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Subject: Packaging Requirement – Foreign Object Elimination (FOE) program

Valued L-3 Electron Devices Supplier:

As part of L-3 Electron Devices Division (EDD) Foreign Object Debris management program, we are changing our packaging requirements for suppliers to eliminate packaging types that can result in debris in our production and test facilities.

Packaging used should avoid the use of Styrofoam “peanuts” or any loose material that can shred or adhere to products when removed from the packaging. Small packaging objects like “peanuts” are acceptable only if contained in small bags that can be easily disposed of and does not result in small pieces of material becoming loose in the package.



Please feel free to contact your buyer representative with any questions.

Thanks for your continued support and assistance.

A handwritten signature in black ink, appearing to read 'Mike McAlister'.

Mike McAlister
VP, QA/Security/IT
L-3 Electron Devices